

500V Super-Junction Power MOSFET

FEATURES

- $\bullet \quad \text{Very low FOM R}_{\text{DS(on)}} \times \text{Q}_{\text{g}} \\$
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information					
Device	TPA50R2K3C	TPP50R2K3C	TPU50R2K3C	TPD50R2K3C	
Package	TO-220	TO-220F	TO-251	TO-252	
Marking	50R2K3C	50R2K3C	50R2K3C	50R2K3C	

Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted					
Parameter		Cuma la a l	Value		l locit
Parameter	Symbol	TO-220,TO-251,TO-252	TO-220F	Unit	
Drain-Source Voltage (V _{GS} = 0V)		$V_{\rm DSS}$	500		V
Continuous Drain Current	I _D 1.4			А	
Pulsed Drain Current (no	te1)	I _{DM}	4.2		А
Gate-Source Voltage		V_{GSS}	±30		V
Single Pulse Avalanche Energy (not	te2)	E _{AS}	1.25		mJ
Avalanche Current (not	te1)	I _{AR}	0.5		А
Repetitive Avalanche Energy (not	netitive Avalanche Energy (note1) E _{AR} 0.03			mJ	
Power Dissipation (T _C = 25°C)		P_{D}	12.3	6	W
Operating Junction and Storage Temperature Range		T_J,T_stg	-55~+150		°C

Thermal Resistance					
Poromotor	Value			11:4	
Parameter	Symbol	TO-220,TO-251,TO-252	TO-220F	Unit	
Thermal Resistance, Junction-to-Case	R _{thJC}	10.2	20.8	17/\\	
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	80	K/W	

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TPA50R2K3C,TPP50R2K3C,TPU50R2K3C,TPD50R2K3C

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Specifications $T_J = 25^{\circ}C$, un		Value					
Parameter	Symbol Test Conditions -		Min.	Тур.	Max.	Unit	
Static				ı			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	500			V	
Zeus Cota Valta de Dusia Cuurant		$V_{DS} = 500V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	_	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 500V, V _{GS} = 0V, T _J = 150°C			100	μΑ	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.0	V	
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 0.7A$		2.1	2.3	Ω	
Forward Transconductance (Note3)	9 _{fs}	$V_{DS} = 10V, I_{D} = 0.7A$		1.0		S	
Dynamic		•					
Input Capacitance	C _{iss}	$V_{GS} = 0V,$ $V_{DS} = 50V,$		120		pF	
Output Capacitance	C _{oss}			25			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		5			
Total Gate Charge	Q_g			4.1		nC	
Gate-Source Charge	Q_{gs}	$V_{DD} = 400V, I_{D} = 1.4A,$ $V_{GS} = 10V$		0.7			
Gate-Drain Charge	Q_{gd}	93 -		2.5			
Turn-on Delay Time	t _{d(on)}			49			
Turn-on Rise Time	t _r	$V_{DD} = 400V, I_{D} = 1.4A,$		17			
Turn-off Delay Time	t _{d(off)}	$R_G = 25\Omega$		24		ns	
Turn-off Fall Time	t _f			19			
Drain-Source Body Diode Characteris	stics						
Continuous Body Diode Current	I _s	T 0500			1.4	۸	
Pulsed Diode Forward Current	I _{SM}	T _C = 25°C			5.6	А	
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 1.4\text{A}, V_{GS} = 0\text{V}$		0.9	1.2	V	
Reverse Recovery Time	t _{rr}			76.6		ns	
Reverse Recovery Charge	Q _{rr}	$V_R = 400V, I_F = I_S,$ $di_F/dt = 100A/\mu s$		0.3		μC	
Peak Reverse Recovery Current	I _{rrm}	_F		3.1		А	

Notes

- 1. Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. I_{AS} = 0.5A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 1%





I_D, Drain Current (A)

5

4

4.5

3.5

2.5

2

1.5

0.5

0

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Figure 2. Transfer Characteristics

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

20V 10V 6V 5.5V 5V 4.5V

l_D, Drain Current (A)

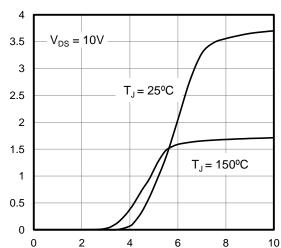


Figure 3. On-Resistance vs. Drain Current

10

V_{DS}, Drain-to-Source Voltage (V)

15

20

5

3.2 $V_{GS} = 10V$ 3 R_{DS(on)}, On-Resistance (Ω) T_J = 25°C 2.8 2.6 2.4 2.2 2 0.5 1.5 2 2.5 3 ID, Drain Current (A)

Figure 4. Capacitance

V_{GS}, Gate-to-Source Voltage (V)

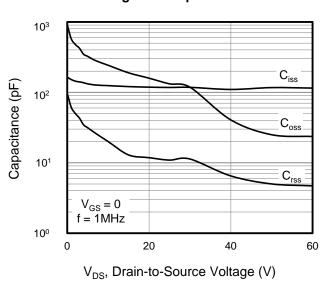


Figure 5. Gate Charge

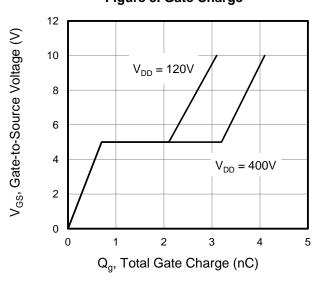
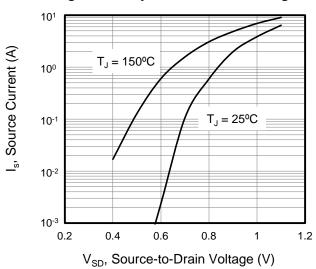


Figure 6. Body Diode Forward Voltage





Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 7. On-Resistance vs.

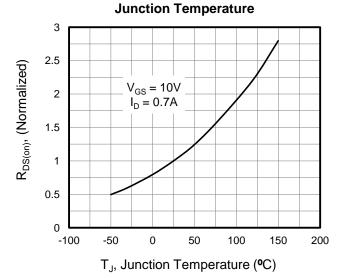


Figure 9. Transient Thermal Impedance TO-220/TO-251/TO-252

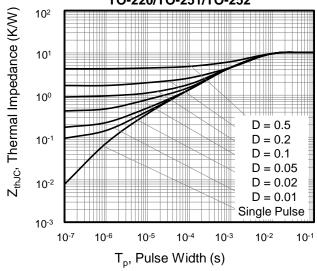


Figure 8. Threshold Voltage vs. Junction Temperature

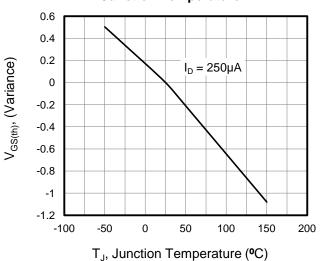
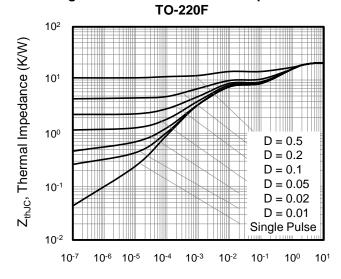


Figure 10. Transient Thermal Impedance



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Figure A: Gate Charge Test Circuit and Waveform

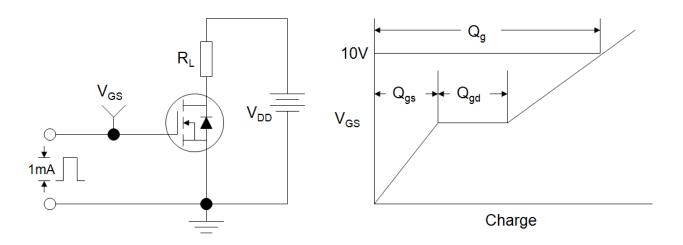


Figure B: Resistive Switching Test Circuit and Waveform

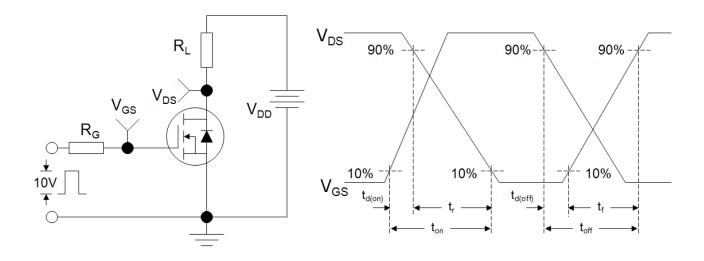
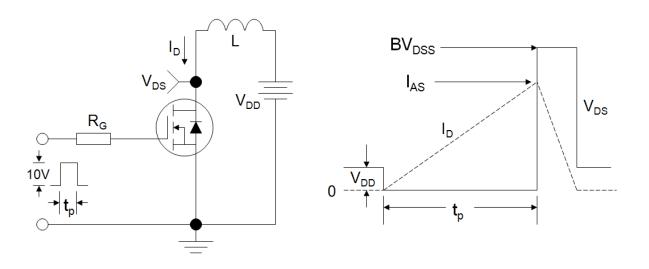


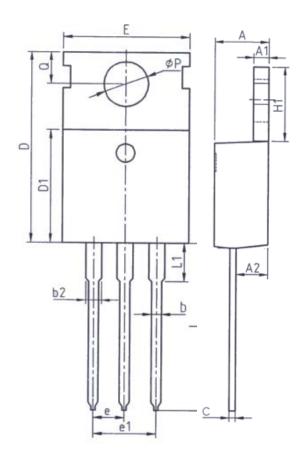
Figure C: Unclamped Inductive Switching Test Circuit and Waveform

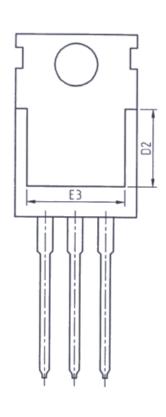


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TO-220

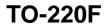


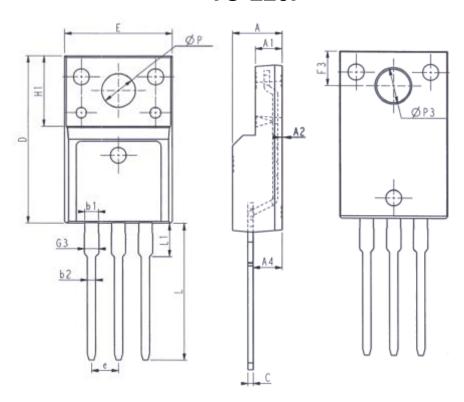


Unit: mm				
Symbol	Min.	Max.		
Α	4. 37	4. 77		
A1	1. 25	1. 45		
A2	2. 20	2. 60		
ь	0. 70	0. 95		
b2	1. 17	1. 47		
С	0. 40	0. 65		
D	15. 10	16. 10		
D1	8. 80	9. 40		
D2	5. 50	_		

Unit: mm				
Symbol	Min.	Max.		
E	9. 70	10. 30		
E3	7. 00	-		
е	2. 54BSC			
e1	5. 08BSC			
H1	6. 25	6. 85		
L	12. 75	13.80		
L1	-	3. 40		
P	3. 40	3. 80		
Q	2. 60	3. 00		

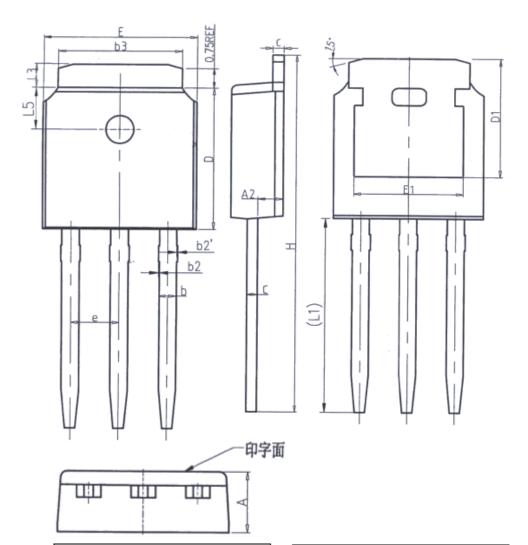






Unit: mm			l	Jnit: mn	1
Symbol	Min.	Max.	Symbol	Min.	Max.
E	9. 96	10. 36	L	12. 68	13. 28
Α	4. 50	4. 90	L1	2. 93	3. 13
A 1	2. 34	2. 74	Р	3. 03	3. 38
A2	0. 30	0.60	Р3	3. 15	3. 65
A4	2. 56	2. 96	F3	3. 15	3. 45
С	0.40	0. 65	G3	1. 25	1. 55
D	15. 57	16. 17	b1	1. 18	1. 43
H1	6. 70REF		b2	0. 70	0. 95
е	2. 54BSC				

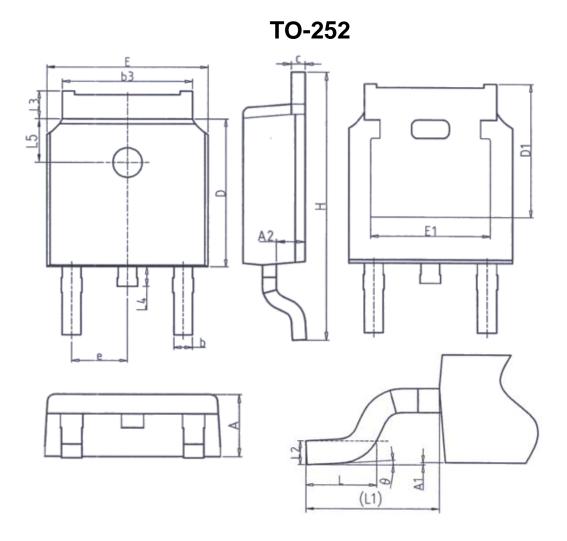
TO-251



Unit: mm				
Symbol	Min.	Max.		
Α	2. 20	2. 40		
A2	0. 97	1. 17		
b	0. 68	0. 90		
b2	0.00	0.10		
b2′	0.00	0.10		
b3	5. 20	5. 50		
С	0. 43	0. 63		
D	5. 98	6. 22		

Unit: mm				
Symbol	Min.	Max.		
D1	5. 30REF			
E	6. 40	6. 80		
E1	4. 63	-		
е	2. 286BSC			
Н	16. 22	16. 82		
L1	9. 15	9. 65		
L3	0.88	1. 28		
L5	1. 65	1. 95		





Unit: mm				
Symbol	Min.	Max.		
Α	2. 20	2. 40		
A1	0.00	0. 20		
A2	0. 97	1. 17		
b	0. 68	0. 90		
b3	5. 20	5. 50		
С	0. 43	0. 63		
D	5. 98	6. 22		
D1	5. 30REF			
E	6. 40	6. 80		
E1	4. 63	_		

Unit: mm				
Symbol	Min.	Max.		
е	2. 286BSC			
Н	9. 40	10.50		
L	1. 38	1. 75		
L1	2. 90REF			
L2	0. 51	IBSC		
L3	0.88	1. 28		
L4	_	1.00		
L5	1. 65	1. 95		
θ	0°	8°		

TPA50R2K3C,TPP50R2K3C,TPU50R2K3C,TPD50R2K3C



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